

CHEQUERS ELECTRONIC (CHINA) LIMITED

捷嘉電子(中國)有限公司

SURFACE-MOUNT (SMD) QUARTZ CRYSTAL UNIT SPECIFICATION

PART NO.: TA6CS12.000MCLAL0-R0

<<This Product is RoHS and REACH Compliant>>

Part no.	:	TA6CS12.000MCLAL0-R0
Printed on	:	30-Jul-14
Prepared	:	Frankie
Ver. Ctrl.	:	073014/F
Page	:	1 of 6

Address : Room 1101-2, Mongkok Commercial Centre, 16 Argyle St.,

Mongkok, Kowloon, Hong Kong SAR, China.

Phone : (852) 2391-6725, (852) 2391-7306, (852) 2391-6158

Fax : (852) 2789-3205, (852) 2789-3349 Homepage : http://www.chequers-electronic.com E-mail : info@chequers-electronic.com

1. Scope

This specification shall cover the characteristics of ceramic resonator TA6CS12.000MCLAL0-R0.

2. Specification no.: QJ-19013-52-2012

3. Part no.: TA6CS12.000MCLAL0-R0

4. Electrical specification

4-1	Nominal oscillating frequency	12.0000MHz
4-2	Frequency tolerance	±30ppm(at 25°C)
4-3	Oscillation Mode	Fundamental
4-4	Shunt Capacitance(C ₀)	7pF max.
4-5	Load Capacitance (C _L)	20pF
4-6	Equivalent Series Resistance	60 Ω max.
4-7	Insulation resistance	5 x 10 ⁸ Ω Min. (at 100V DC)
4-8	Temperature stability (-20°C to +70°C)	±30ppm
	Operating temperature	-20°C to +70°C
	Storage temperature	-40°C to +85°C
4-9	Aging (at 25°C)	±5ppm max. per year

5. Physical characteristics

	Test item	Condition of test	Performance requirement
5-1	Random drop	The quartz crystal shall be measured after 2 random drops from the height of 0.75m on wooden floor.	No visible damage and the measured values shall meet Table 1.
5-2	Vibration	The measured values shall meet Table 1.	
5-3	PCB bending strength	Mount quartz crystal on a glass-epoxy board (100x50x1.6mm). Then the board is bent to 1.0mm displacement and kept in this condition for 5 seconds (see below for details).	No visible damage and the measured values shall meet Table 1.

:	TA6CS12.000MCLAL0-R0
:	30-Jul-14
:	Frankie
:	073014/F
:	2 of 6
	:

	Test item	Conditio	Condition of test		
5-4	Soldering heat resistance	Temperature profile of real The quartz crystal shall be placed in room temperature Tem. (°C) Peak:260°C Pre-heating within 80-120s.	measured after being	The measured values shall meet Table 1.	
5-5	Soldering test	Passed through the reflow condition and left at room to before measurement. Surface temperature of the substrate Preheat: 150°C±5°C Peak: 260°C±5°C			
5-6	Solderability	Peak: 260°C±5°C 5secs ± 3secs Dipped in 235°C±5°C solder bath for 3secs ± 0.5secs with rosin flux (25wt% ethanol solution).		Terminals should be at least 95% covered by solder.	

6. Environmental characteristics

	Test item	Condition of test	Performance requirement
6-1	High temperature storage	After being placed in a chamber (+85°C±2°C) for 500 hours, the quartz crystal unit is measured after being placed in room temperature for 1 hour.	The measured values shall meet Table 1.
6-2	Low temperature storage	After being placed in a chamber (-40°C±2°C) for 500 hours, the quartz crystal unit is measured after being placed in room temperature for 1 hour.	The measured values shall meet Table 1.
6-3	Humidity	After being placed in a chamber with a humidity of 90% to 95% RH and a temperature of +40°C±2°C for 500 hours, the quartz crystal is measured after being placed in room temperature for 1 hour.	The measured values shall meet Table 1.
6-4	Heat shock	After being kept at room temperature, the quartz crystal shall be placed at a temperature of -25°C. After 30 minutes at this temperature, the quartz crystal unit is placed at a temperature of 85°C. After another 30 minutes at this temperature, the quartz crystal is placed under -20°C again. The above processes are counted as 1 cycle. There is a transfer time of 15 seconds between different temperatures. After 5 cycles, the quartz crystal shall be measured after being placed in room temperature for 1 hour.	The measured values shall meet Table 1.

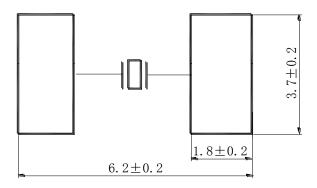
Part no.	:	TA6CS12.000MCLAL0-R0
Printed on	:	30-Jul-14
Prepared	:	Frankie
Ver. Ctrl.	:	073014/F
Page	:	3 of 6

Table 1

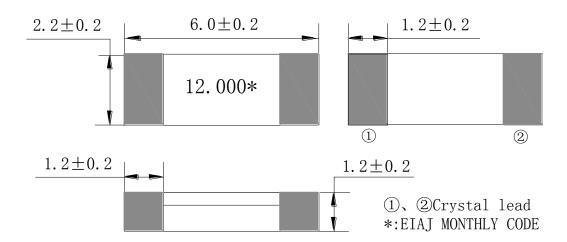
Measurements	Requirements
Frequency tolerance at 25°C	±30ppm
Equivalent Series	60Ω max.
Resistance	

7. Dimensions and recommended soldering pattern

7-1 Recommended soldering pattern (Unit: mm)



7-2 Dimensions (Unit: mm)



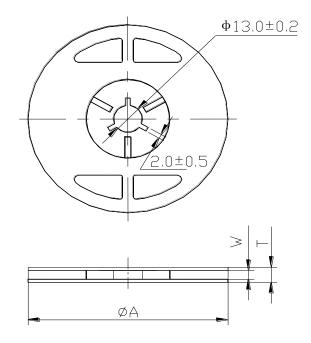
EIAJ Monthly Code

2011/2013/2015/2017		2010/2012/2014/2016	
MONTH	CODE	MONTH CODE	
JAN	А	JAN	N
FEB	В	FEB	Р
MAR	С	MAR	Q
APR	D	APR	R
MAY	Е	MAY	S
JUN	F	JUN	Т
JUL	G	JUL	U
AUG	Н	AUG	V
SEP	J	SEP	W
OCT	K	OCT	Х
NOV	L	NOV	Υ
DEC	М	DEC	Z

Part no.	:	TA6CS12.000MCLAL0-R0
Printed on	:	30-Jul-14
Prepared	:	Frankie
Ver. Ctrl.	:	073014/F
Page	:	4 of 6

8. Packing information

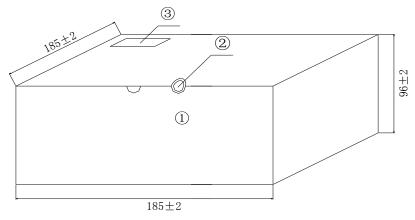
8-1 Reel Dimensions (Unit: mm)



Dimensions (Unit: mm)

φА	W	T	Pieces per reel	Carrier tape size
180±3	16.4min	22.4max	1000typ.	16

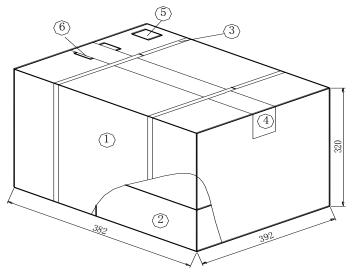
8-2 Inner box Dimensions (Unit: mm)



No.	Name	Quantity
1	Inner Box	1
2	QC Label	1
3	Label	1

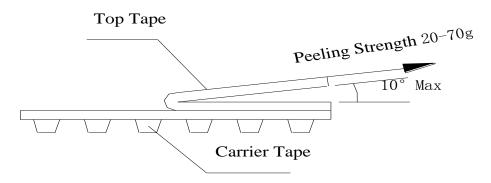
Part no.	:	TA6CS12.000MCLAL0-R0	
Printed on	:	30-Jul-14	
Prepared	:	Frankie	
Ver. Ctrl.	:	073014/F	
Page	:	5 of 6	

8-3 Tape Dimensions (Unit: mm)

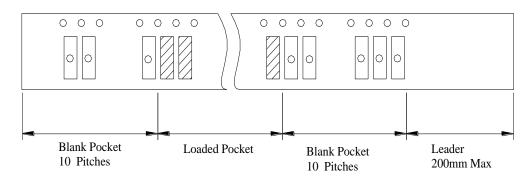


No.	Name	Quantity
1	Package	1
2	Inner box	12 boxes
3	Belt	2.90mm
4	Adhesive tape	1.2m
5	Label	1
6	Certifcate of approval	1

8-4 Peeling Strength



8-5 Packing Method Sketch Map



Part no.	:	TA6CS12.000MCLAL0-R0
Printed on	:	30-Jul-14
Prepared	:	Frankie
Ver. Ctrl.	:	073014/F
Page	:	6 of 6
		·